Common-mode EMI filter for differential channels with integrated ESD protection

Rev. 2 — 19 April 2016

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Common-mode ElectroMagnetic Interference (EMI) filters with integrated ElectroStatic Discharge (ESD) protection for one, two and three differential channels. The devices are designed to provide low insertion loss for differential high-speed signals on each channel while unwanted common-mode signals are attenuated.

Each differential channel incorporates two signal lines that are coupled by integrated coils. Diodes provide protection to downstream components from ESD voltages up to  $\pm$ 15 kV on each signal line.

#### Table 1.Product overview

Type number	Number of channels	Package Name
PCMF1HDMI2S	1	WLCSP5
PCMF2HDMI2S	2	WLCSP10
PCMF3HDMI2S	3	WLCSP15

### **1.2 Features and benefits**

- One, two and three differential channels common-mode EMI filters with integrated ESD protection
- ESD protection up to ±15 kV contact discharge according to IEC 61000-4-2
- Superior common-mode suppression over a wide frequency range
- Superior RF performance compared to other integrated filters or discrete filters with external ESD protection
- Extremely high symmetry between line pairs
- Industry-standard Wafer Level Chip Scale Packages: WLCSP5, 10 and 15 for smaller footprint

### **1.3 Applications**

- Smartphone, cellular and cordless phone
- Tablet PC and Mobile Internet Device (MID)
- HDMI 2.0, HDMI 1.4
- MIPI M-PHY and D-PHY as used in Camera Serial Interface (CSI) and Display Serial Interface (DSI)
- General-purpose EMI and Radio-Frequency Interference (RFI) filter and downstream ESD protection



Common-mode EMI filter for differential channels with ESD protection

## 2. Pinning information

Table	2. Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
PCMF	THDMI2S (WLCS	SP5_2-1-2)		
A1	CH1_IN+	channel 1+, external		
A2	CH1_IN-	channel 1-, external		
B1	GND_CH1	ground channel 1		A202
C1	CH1_OUT+	channel 1+, internal		
C2	CH1_OUT-	channel 1-, internal	A B C	
			Transparent top view	
			WLCSP5_2-1-2	는 프 B1
				aaa-019784
PCMF	2HDMI2S (WLCS	SP10_4-2-4)	1	1
A1	CH1_IN+	channel 1+, external		A4.2
A2	CH1_IN-	channel 1-, external		A1, 3 C1, 3 C1, 4 C2, 4 C2, 4
A3	CH2_IN+	channel 2+, external		Γζ, τ <u> </u>
A4	CH2_IN-	channel 2-, external		
B1	GND_CH1	ground channel 1		4 4
B2	GND_CH2	ground channel 2		
C1	CH1_OUT+	channel 1+, internal		–– B1, B2 - no internal connection
C2	CH1_OUT-	channel 1-, internal	A B C	aaa-019785
C3	CH2_OUT+	channel 2+, internal	Transparent top view	
C4	CH2_OUT-	channel 2-, internal	WLCSP10_4-2-4	
PCMF	3HDMI2S (WLCS	SP15_6-3-6)		
A1	CH1_IN+	channel 1+, external		A4.2.5 C4.2.5
A2	CH1_IN-	channel 1-, external		A1, 3, 5 C1, 3, 5 C1, 3, 5 C2, 4, 6 C2, 4, 6
A3	CH2_IN+	channel 2+, external		
A4	CH2_IN-	channel 2–, external	5	
A5	CH3_IN+	channel 3+, external		4 4
A6	CH3_IN-	channel 3-, external		
B1	GND_CH1	ground channel 1	3	는 B1, B2, B3 - no internal connection
B2	GND_CH2	ground channel 2		aaa-019786
B3	GND_CH3	ground channel 3		
C1	CH1_OUT+	channel 1+, internal		
C2	CH1_OUT-	channel 1-, internal		
C3	CH2_OUT+	channel 2+, internal	A B C Transparent top view	
C4	CH2_OUT-	channel 2-, internal	- WLCSP15_6-3-6	
C5	CH3_OUT+	channel 3+, internal		
C6	CH3_OUT-	channel 3–, internal		

#### Common-mode EMI filter for differential channels with ESD protection

## 3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PCMF1HDMI2S	WLCSP5	wafer level chip-size package; 5 bumps (2-1-2)	PCMF1HDMI2S			
PCMF2HDMI2S	WLCSP10	wafer level chip-size package; 10 bumps (4-2-4)	PCMF2HDMI2S			
PCMF3HDMI2S	WLCSP15	wafer level chip-size package; 15 bumps (6-3-6)	PCMF3HDMI2S			

## 4. Marking

#### Table 4.Marking codes

Type number	Marking code
PCMF1HDMI2S	PF1S
PCMF2HDMI2S	PF2S
PCMF3HDMI2S	PF3S

## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		-0.5	5	V
V <sub>ESD</sub>	electrostatic discharge voltage	IEC 61000-4-2, level 4; all input pins to ground			
		contact discharge	-15	15	kV
		air discharge	-15	15	kV
		IEC 61000-4-2, level 4; all output pins to ground			
		contact discharge	-2	2	kV
		air discharge	-2	2	kV
I <sub>PPM</sub>	rated peak pulse current	t <sub>p</sub> = 8/20 μs	-7	7	A
T <sub>stg</sub>	storage temperature		-40	+125	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C

Common-mode EMI filter for differential channels with ESD protection

## 6. Characteristics

### 6.1 Channel characteristics

#### Table 6. Channel characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>s(ch)</sub>	channel series resistance	single line; input to output	-	3	-	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>I</sub> = 2.5 V [1]	-	0.25	-	pF
I <sub>RM</sub>	reverse leakage current	per line; V <sub>I</sub> = 5 V	-	-	100	nA
V <sub>BR</sub>	breakdown voltage	I <sub>R</sub> = 1 mA	6	9	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 mA	-	0.8	-	V
V <sub>CL</sub>	clamping voltage	TLP [2]				
		I <sub>PP</sub> = -16 A	-	-3.7	-	V
		I <sub>PP</sub> = -8 A	-	-2.5	-	V
		I <sub>PP</sub> = 8 A	-	2.8	-	V
		I <sub>PP</sub> = 16 A	-	4	-	V
R <sub>dyn</sub>	dynamic resistance	TLP [2]				
		positive transient	-	0.16	-	Ω
		negative transient	-	0.16	-	Ω
		surge [3]				
		positive transient	-	0.22	-	Ω
		negative transient	-	0.22	-	Ω

[1] This parameter is guaranteed by design.

[2] 100 ns Transmission Line Pulse (TLP); 50  $\Omega$ ; pulser at 70 ns to 90 ns.

[3] According to IEC 61000-4-5 (8/20 μs).

### 6.2 Frequency characteristics

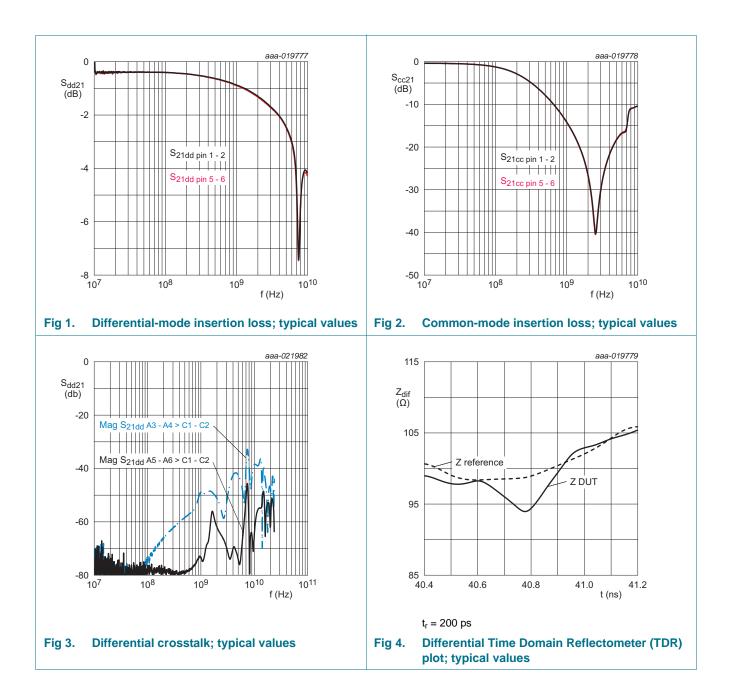
#### Table 7.Frequency characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Commor	mode: S <sub>21cc</sub>						
$\alpha_{il}$	insertion loss		[1]				
		f = 800 MHz		-	-12	-	dB
		f = 1.7 GHz		-	-21.5	-	dB
		f = 3 GHz		-	-31.5	-	dB
Different	ial mode: S <sub>21dd</sub>						
α <sub>il</sub>	insertion loss	f = 1 MHz	[1]	-	0.3	-	dB
f <sub>-3dB</sub>	cut-off frequency		[1]	-	6	-	GHz

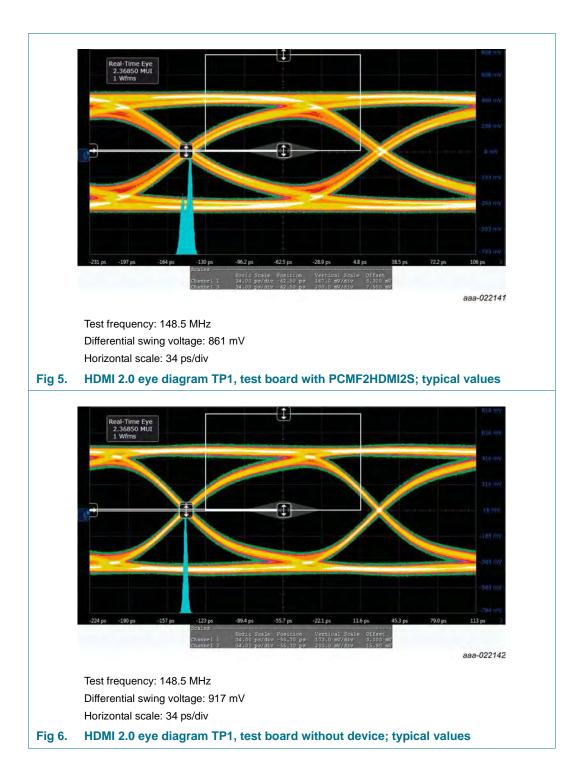
[1] Normalized to attenuation at 1 MHz.

# **PCMFXHDMI2S** series

Common-mode EMI filter for differential channels with ESD protection

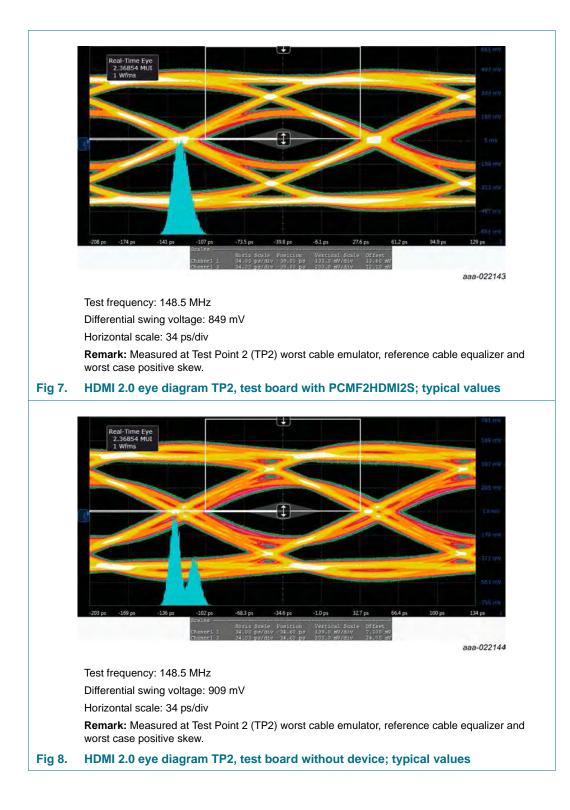


Common-mode EMI filter for differential channels with ESD protection



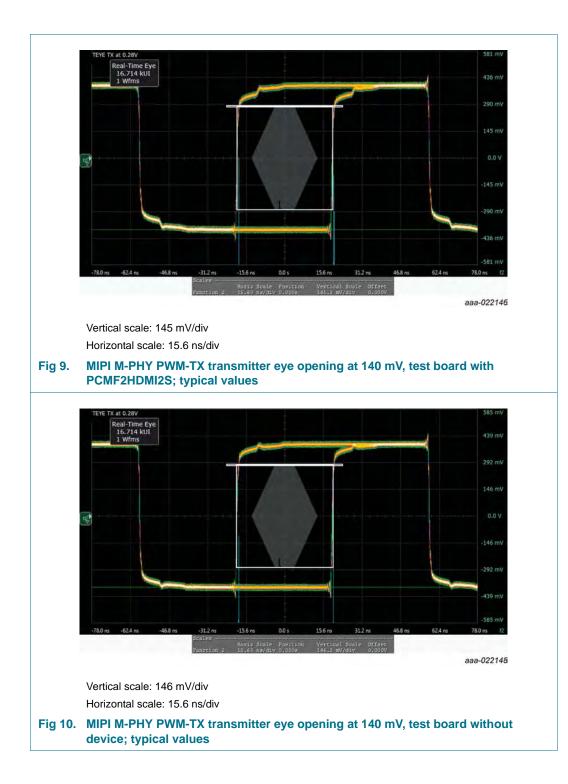
PCMFXHDMI2S\_SER
Product data sheet

#### Common-mode EMI filter for differential channels with ESD protection

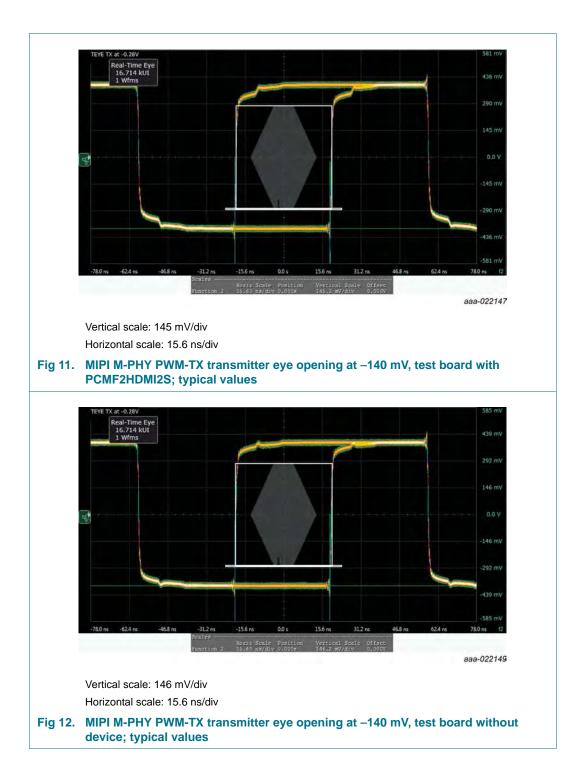


Product data sheet

Common-mode EMI filter for differential channels with ESD protection

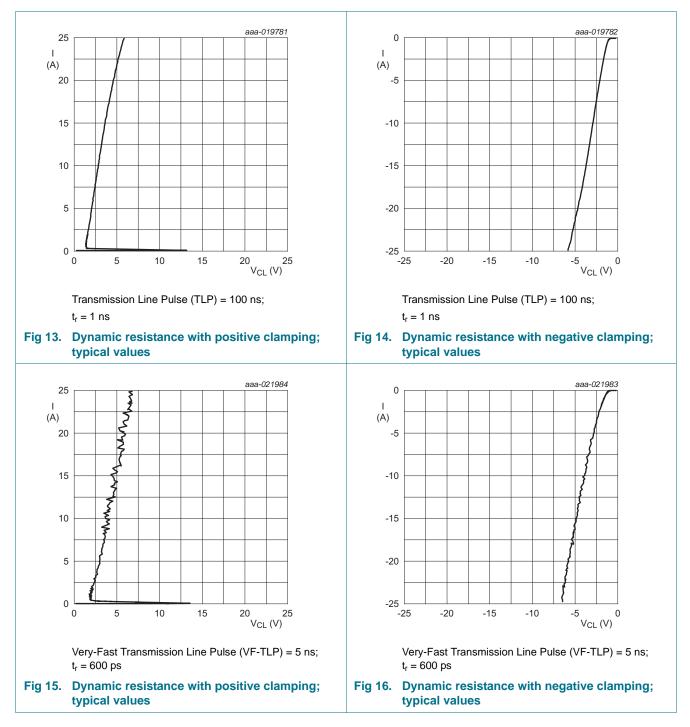


Common-mode EMI filter for differential channels with ESD protection



# **PCMFXHDMI2S** series

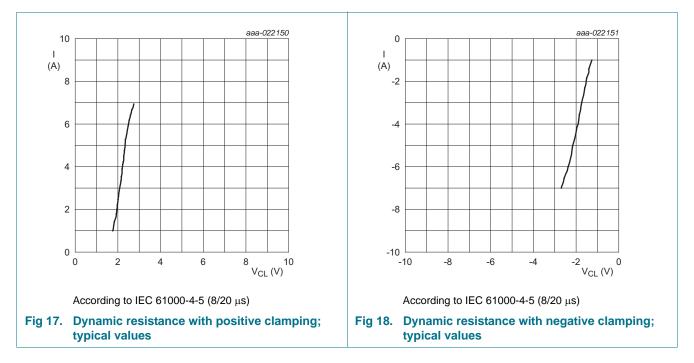
#### Common-mode EMI filter for differential channels with ESD protection



The device uses an advanced clamping structure showing a negative dynamic resistance. This snapback behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snapback state after exceeding breakdown voltage (due to an ESD pulse for instance).

# **PCMFXHDMI2S** series

Common-mode EMI filter for differential channels with ESD protection



### 7. Application information

The device is designed to provide high-level ESD protection and common-mode filtering for differential high-speed data line pairs such as:

- HDMI 2.0
- Transition-Minimized Differential Signaling (TMDS)
- DisplayPort
- external Serial Advanced Technology Attachment (eSATA)
- Low Voltage Differential Signaling (LVDS)

When designing the PCB, give careful consideration to impedance matching and signal coupling. Do not connect the protected signal lines to unlimited current sources like, for example, a battery.

Common-mode EMI filter for differential channels with ESD protection

### 8. Package outline

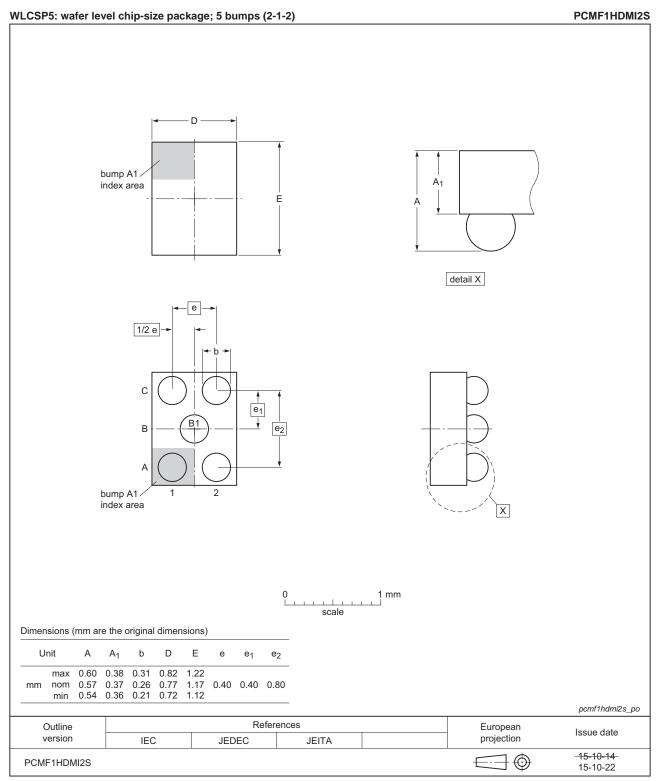
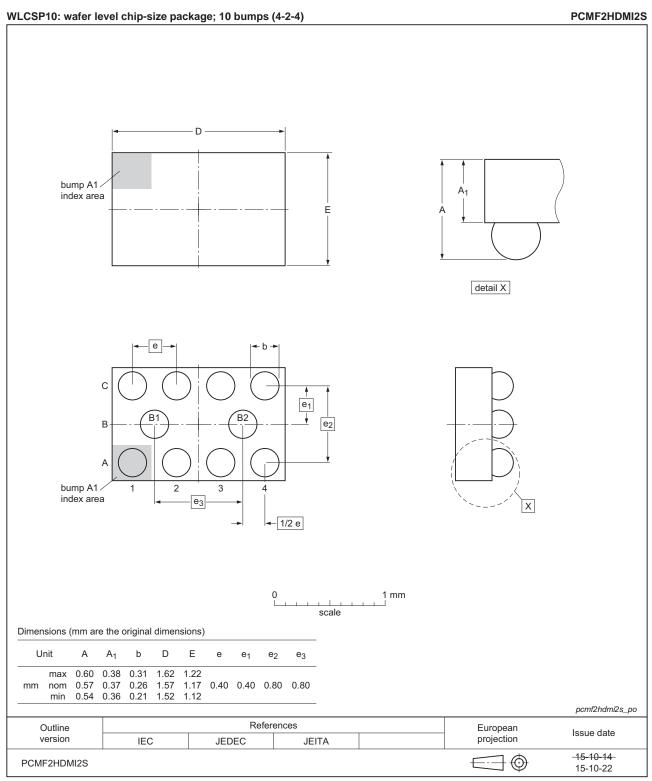


Fig 19. Package outline WLCSP5

All information provided in this document is subject to legal disclaimers.

# **PCMFXHDMI2S** series

#### Common-mode EMI filter for differential channels with ESD protection



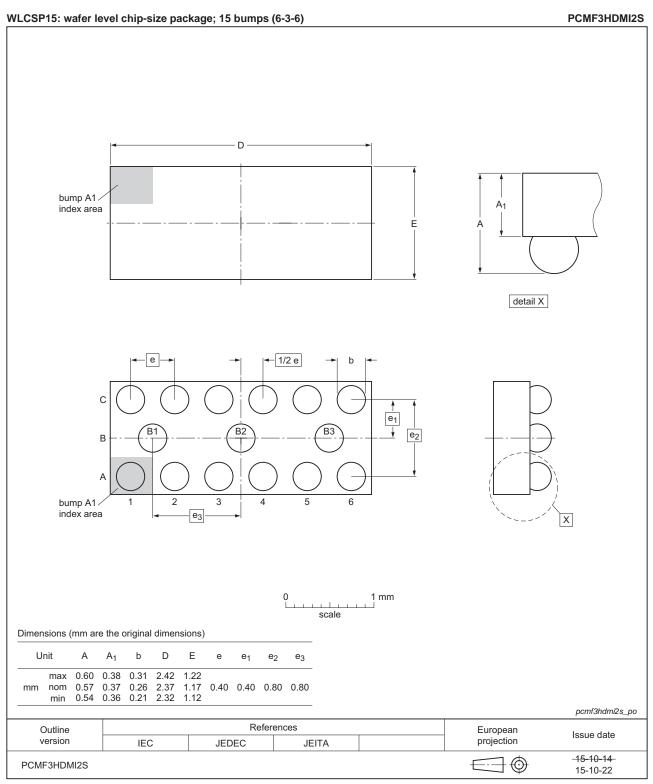
#### Fig 20. Package outline WLCSP10

PCMFXHDMI2S\_SER

**Product data sheet** 

# **PCMFXHDMI2S** series

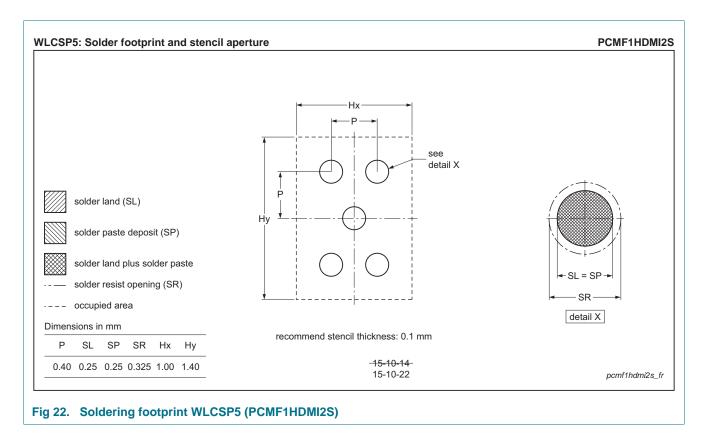
#### Common-mode EMI filter for differential channels with ESD protection



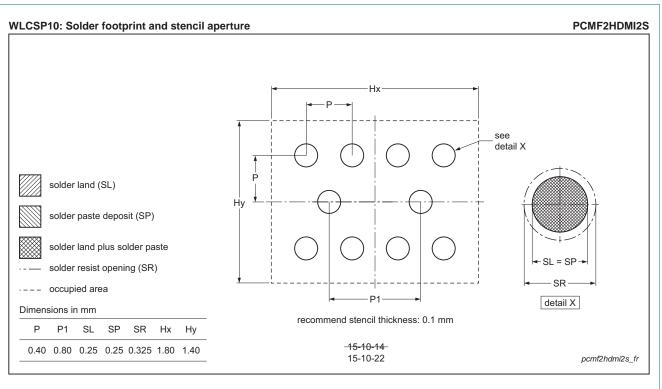
#### Fig 21. Package outline WLCSP15

Common-mode EMI filter for differential channels with ESD protection

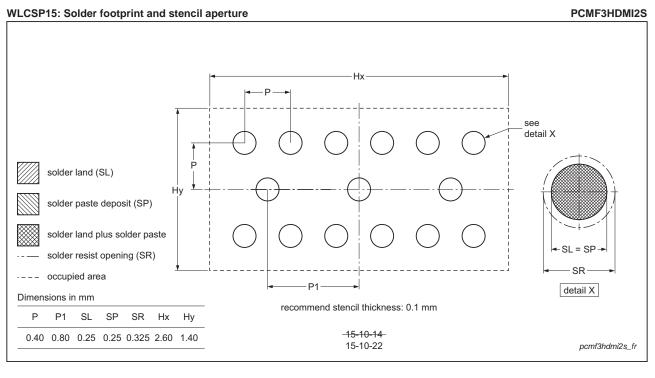
## 9. Soldering



#### Common-mode EMI filter for differential channels with ESD protection



#### Fig 23. Soldering footprint WLCSP10 (PCMF2HDMI2S)



#### Fig 24. Soldering footprint WLCSP15 (PCMF3HDMI2S)

PCMFXHDMI2S\_SER

16 of 20

Common-mode EMI filter for differential channels with ESD protection

## **10. Revision history**

#### Table 8.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCMFXHDMI2S_SER v.2	20160419	Product data sheet	-	PCMFXHDMI2S_SER v.1
Modifications:	<u>Section 1 "Product profile"</u> : updated			
	Section 6.1: clar	nping voltage V <sub>CL</sub> added; o	dynamic resistance R	<sub>dyn</sub> updated
	Section 6.2: inse	ertion loss $\alpha_{il}$ updated		
	• Figure 3: added			
	• Figure 5 to Figure	re 8: updated		
	• Figure 9 to Figure	re 12 and Figure 15 to Figu	ure 18: added	
	Section 7 "Applie	cation information": added		
PCMFXHDMI2S_SER v.1	20151126	Preliminary data sheet	-	-

Common-mode EMI filter for differential channels with ESD protection

## 11. Legal information

### 11.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### 11.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 11.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP Semiconductors N.V. 2016. All rights reserved.

# **PCMFXHDMI2S** series

#### Common-mode EMI filter for differential channels with ESD protection

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in

automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the

product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### 11.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## **12. Contact information**

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

# **PCMFXHDMI2S** series

Common-mode EMI filter for differential channels with ESD protection

### 13. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 2
3	Ordering information 3
4	Marking 3
5	Limiting values 3
6	Characteristics 4
6.1	Channel characteristics 4
6.2	Frequency characteristics 4
7	Application information 11
8	Package outline 12
9	Soldering 15
10	Revision history 17
11	Legal information 18
11.1	Data sheet status 18
11.2	Definitions 18
11.3	Disclaimers
11.4	Trademarks 19
12	Contact information 19
13	Contents 20

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2016.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 19 April 2016 Document identifier: PCMFXHDMI2S\_SER

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for nxp manufacturer:

Other Similar products are found below :

MC13211R2 PCA9518PW,112 LFSTBEB865X MC33399PEFR2 PCA9551PW,112 MC34825EPR2 CBTW28DD14AETJ PCF8583P MC68340AB16E MC8640DTVJ1250HE EVBCRTOUCH MC9S08PT16AVLC MC9S08PT8AVTG MC9S08SH32CTL MCF54415CMJ250 MCIMX6Q-SDB MCIMX6SX-SDB 74ALVC125BQ,115 74HC4050N 74HC4514N MK21FN1M0AVLQ12 MKV30F128VFM10 FRDM-K66F FRDM-KW40Z FRDM-MC-LVBLDC PESD18VF1BSFYL PMF63UNEX PSMN4R0-60YS,115 HEF4028BPN RAPPID-567XFSW MPC565MVR56 MPC574XG-176DS MPC860PCVR66D4 BT137-600E BT138-600E.127 BT139X-600.127 BT258-600R.127 BUK7628-100A118 BUK765R0-100E.118 P5020NSE7VNB S12ZVML12EVBLIN SCC2692AC1N40 LPC1785FBD208K LPC2124FBD64/01 LS1020ASN7KQB LS1020AXN7HNB LS1020AXN7KQB LS1043ASE7PQA T1023RDB-PC FRDM-KW24D512